

FB2031
9-bit latched/registered/pass-thru Futurebus+ transceiver

Product specification
IC19 Data Handbook

## FEATURES

- Latched, registered or straight through in either A to B or B to A path
- Drives heavily loaded backplanes with equivalent load impedances down to $10 \Omega$.
- High drive 100 mA BTL open collector drivers on B-port
- Allows incident wave switching in heavily loaded backplane buses
- Reduced BTL voltage swing produces less noise and reduces power consumption
- Built-in precision band-gap reference provides accurate receiver thresholds and improved noise immunity
- Compatible with IEEE Futurebus+ or proprietary BTL backplanes
- Each BTL driver has a dedicated Bus GND for a signal return
- Controlled output ramp and multiple GND pins minimize ground bounce
- Glitch-free power up/power down operation
- Low ICC current
- Tight output skew
- Supports live insertion

QUICK REFERENCE DATA

| SYMBOL | PARAMETER |  | TYPICAL | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \hline \mathrm{tPLH} \\ & \mathrm{t}_{\mathrm{tPHL}} \end{aligned}$ | Propagation delay An to Bn |  | 2.7 | ns |
| $\begin{aligned} & \hline \mathrm{t}_{\mathrm{PLH}} \\ & \mathrm{t}_{\mathrm{PHL}} \end{aligned}$ | Propagation delay <br> Bn to An |  | $\begin{aligned} & 4.4 \\ & 4.2 \end{aligned}$ | ns |
| $\mathrm{C}_{0}$ | Output capacitance ( $\overline{\mathrm{B0}}$ - $\overline{\mathrm{Bn}}$ only) |  | 6 | pF |
| loL | Output current ( $\overline{\mathrm{BO}}$ - $\overline{\mathrm{Bn}}$ only) |  | 100 | mA |
| $I_{\text {cc }}$ | Supply current | Aln to Bn (outputs Low or High) | 17 |  |
|  |  | $\overline{\mathrm{Bn}}$ to AOn (outputs Low) | 50 | mA |
|  |  | $\overline{\text { Bn }}$ to AOn (outputs High) | 25 |  |

ORDERING INFORMATION

| PACKAGE | COMMERCIAL RANGE <br> $\mathrm{v}_{\mathrm{cc}}=5 \mathrm{~V} \pm 10 \% ; \mathrm{T}_{\mathrm{amb}}=\mathbf{0}^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | INDUSTRIAL RANGE <br> $\mathrm{v}_{\mathrm{cc}}=5 \mathrm{~V} \pm 10 \% ; \mathrm{T}_{\mathrm{amb}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | DRAWING <br> NUMBER |
| :---: | :---: | :---: | :---: |
| 52-pin Plastic Quad Flat Pack (QFP) | FB2031BB | CD3206BB | SOT379-1 |

## PIN CONFIGURATION



## DESCRIPTION

The FB2031 is a 9-bit latched/registered transceiver featuring a latched, registered or pass-thru mode in either the A-to-B or B-to-A direction. The FB2031 is intended to provide the electrical interface to a high performance wired-OR bus.

The TTL-level side (A port) has a common $\mathrm{I} / \mathrm{O}$. The common I/O, open collector B port operates at BTL signal levels. The logic element for data flow in each direction is controlled by two mode select inputs (SELO and SEL1). A "00" configures latches in both directions. A "10" configures thru mode in both directions. A "01" configures register mode in both directions. A "11" configures register mode in the A-to-B direction and latch mode in the B-to-A direction.

When configured in the buffer mode, the inverse of the input data appears at the output port. In the register mode, data is stored on the rising edge of the appropriate clock input (LCAB or LCBA). In the latch mode, clock pins serve as transparent-Low latch enables. Regardless of the mode, data is inverted from input to output.
The 3-State A port is enabled by asserting a High level on OEA. The B port has two output enables, OEB0 and OEB1. Only when OEB0 is High and OEB1 is Low is the output enabled.

When either OEB0 is Low or OEB1 is High, the B port is inactive and is pulled to the level of the pullup voltage. New data can be entered in the register and latched modes or can be retained while the associated outputs are in 3-State (A port) or inactive (B port).

The B-port drivers are Low-capacitance open collectors with controlled ramp and are designed to sink 100mA. Precision band gap references on the B-port insure very good noise margins by limiting the switching threshold to a narrow region centered at 1.55 V .

The B-port interfaces to "Backplane Transceiver Logic" (see the IEEE 1194.1 BTL standard). BTL features low power consumption by reducing voltage swing (1V $\mathrm{p}-\mathrm{p}$, between 1 V and 2 V ) and reduced capacitive loading by placing an internal series diode on the drivers. BTL also provides incident wave switching, a necessity for high performance backplanes.

Output clamps are provided on the BTL outputs to further reduce switching noise. The " $\mathrm{V}_{\mathrm{OH}}$ " clamp reduces inductive ringing effects during a Low-to-High transition. The " $\mathrm{V}_{\mathrm{OH}}$ " clamp is always active. The other clamp, the "trapped reflection" clamp, clamps out ringing below the BTL $0.5 \mathrm{~V} \mathrm{~V}_{\mathrm{OL}}$ level. This clamp remains active for approximately 100ns after a High-to-Low transition.

To support live insertion, OEBO is held Low during power on/off cycles to insure glitchfree B port drivers. Proper bias for B port drivers during live insertion is provided by the BIAS V pin when at a 5 V level while $\mathrm{V}_{\mathrm{Cc}}$ is Low. The BIAS V pin is a low current input which will reverse-bias the BTL driver series Schottky diode, and also bias the B port output pins to a voltage between 1.62 V and 2.1V. This bias function is in accordance with IEEE BTL Standard 1194.1. If live insertion is not a requirement, the BIAS V pin should be tied to a $V_{C C}$ pin.
The LOGIC GND and BUS GND pins are isolated inside the package to minimize noise coupling between the BTL and TTL sides. These pins should be tied to a common ground external to the package.
Each BTL driver has an associated BUS GND pin that acts as a signal return path and these BUS GND pins are internally isolated from each other. In the event of a ground return fault, a "hard" signal failure occurs instead of a pattern dependent error that may be infrequent and impossible to troubleshoot.
As with any high power device, thermal considerations are critical. It is recommended that airflow (3001fpm) and/or thermal mounting be used to ensure proper junction temperature.

## PACKAGE THERMAL CHARACTERISTICS

| PARAMETER | CONDITION | 52-PIN PLASTIC QFP |
| :---: | :--- | :---: |
| $\theta j a$ | Still air | $80^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\theta j a$ | 300 Linear feet per minute air flow | $58^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\theta \mathrm{jc}$ | Thermally mounted on one side to heat sink | $20^{\circ} \mathrm{C} / \mathrm{W}$ |

## PIN DESCRIPTION

| SYMBOL | PIN NUMBER | TYPE | NAME AND FUNCTION |
| :---: | :---: | :---: | :--- |
| A0 - A8 | $50,52,2,4,6,8,10,12,14$ | I/O | BiCMOS data inputs/3-State outputs (TTL) |
| B0 - B8 | $40,38,36,34,32$, | I/O | Data inputs/Open Collector outputs, High current drive (BTL) |
| OEB0 | $30,28,26,24$ | Input | Enables the B outputs when High |
| OEB1 | 46 | Input | Enables the B outputs when Low |
| OEA | 45 | Input | Enables the A outputs when High |
| BUS GND | $25,27,29,31,33$, | GND | Bus ground (0V) |
| LOGIC GND | $51,1,3,5,7,9,11,13$ | GND | Logic ground (0V) |
| VCC | $23,43,49$ | Power | Positive supply voltage |
| BIAS V | 48 | Power | Live insertion pre-bias pin |
| BG VCC | 17 | Power | Band Gap threshold voltage reference |
| BG GND | 19 | GND | Band Gap threshold voltage reference ground |
| SEL0 | 20 | Input | Mode select |
| SEL1 | 15 | Input | Mode select |
| LCAB | 18 | Input | A to B clock/latch enable (transparent latch when Low) |
| LCBA | 16 | Input | B to A clock/latch enable (transparent latch when Low) |
| TMS | 42 | Input | Test Mode Select (optional, if not implemented then no connect) |
| TCK | 44 | Input | Test Clock (optional, if not implemented then no connect) |
| TDI | 22 | Input | Test Data In (optional, if not implemented then no connect) |
| TDO | 21 | Output | Test Data Out (optional, if not implemented then shorted to TDI) |

FUNCTION TABLE

| MODE | INPUTS |  |  |  |  |  |  |  |  | OUTPUTS |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | An | Bn* | OEBO | OEB1 | OEA | LCAB | LCBA | SELO | SEL1 | An | $\overline{\mathrm{Bn}}$ |
| An to $\overline{B n}$ thru mode | L | - | H | L | L | X | X | H | L | input | $\mathrm{H}^{* *}$ |
|  | H | - | H | L | L | X | X | H | L | input | L |
| An to $\overline{\mathrm{Bn}}$ transparent latch | L | - | H | L | L | L | X | L | L | input | $\mathrm{H}^{* *}$ |
|  | H | - | H | L | L | L | X | L | L | input | L |
| An to Bn latch and read | I | - | H | L | L | $\uparrow$ | X | L | L | input | $\mathrm{H}^{* *}$ |
|  | h | - | H | L | L | $\uparrow$ | X | L | L | input | L |
| $\overline{\overline{B n}}$ outputs latched and read (preconditioned latch) | X | - | H | L | X | H | X | L | L | X | latched data |
| An to Bn register | 1 | - | H | L | L | $\uparrow$ | X | X | H | input | $\mathrm{H}^{* *}$ |
|  | h | - | H | L | L | $\uparrow$ | X | X | H | input | L |
| Bn to An thru mode | - | L | Disable |  | H | X | X | H | L | H | input |
|  | - | H | Disable |  | H | X | X | H | L | L | input |
| $\overline{\mathrm{Bn}}$ to An transparent latch | - | L | Disable |  | H | X | L | L | L | H | input |
|  | - | H | Disable |  | H | X | L | L | L | L | input |
|  | - | L | Disable |  | H | X | L | H | H | H | input |
|  | - | H | Disable |  | H | X | L | H | H | L | input |
| $\overline{\mathrm{Bn}}$ to An latch and read | - | I | Disable |  | H | X | $\uparrow$ | L | L | H | input |
|  | - | h | Disable |  | H | X | $\uparrow$ | L | L | L | input |
|  | - | 1 | Disable |  | H | X | $\uparrow$ | H | H | H | input |
|  | - | h | Disable |  | H | X | $\uparrow$ | H | H | L | input |
| An outputs latched and read (preconditioned latch) | - | X | X | X | H | X | H | L | L | latched data | X |
|  | - | X | X | X | H | X | H | H | H | latched data | X |
| Bn to An register | - | I | Disable |  | H | X | $\uparrow$ | L | H | H | input |
|  | - | h | Disable |  | H | X | $\uparrow$ | L | H | L | input |
| Disable Bn outputs | X | X | L | X | X | X | X | X | X | X | $\mathrm{H}^{* *}$ |
|  | X | X | X | H | X | X | X | X | X | X | $\mathrm{H}^{* *}$ |
| Disable An outputs | X | X | X | X | L | X | X | X | X | Z | X |

FUNCTION SELECT TABLE

| MODE SELECTED | SELO | SEL1 |
| :--- | :---: | :---: |
| Thru mode | H | L |
| Register mode (An to Bn) | X | H |
| Latch mode (An to Bn) | L | L |
| Register mode (Bn to An) | L | H |
| Latch mode (Bn to An) | L | L |
|  | H | H |

## NOTES:

$\mathrm{H}=$ High voltage level
L = Low voltage level
I = Low voltage level one set-up time prior to the Low-to-High LCXX transition $h=$ High voltage level one set-up time prior to the Low-to-High LCXX transition

X = Don't care
$Z=$ High-impedance (OFF) state

- = Input not externally driven
$\uparrow=$ Low-to-High transition
$H^{* *}=$ Goes to level of pull-up voltage
$\overline{B n}^{*}=$ Precaution should be taken to ensure B inputs do not float. If they do, they are equal to Low state.
Disable $=\mathrm{OEB0}$ is Low or $\overline{\mathrm{OEB1}}$ is High.

LOGIC DIAGRAM


## ABSOLUTE MAXIMUM RATINGS

Operation beyond the limits set forth in this table may impair the useful life of the device.
Unless otherwise noted these limits are over the operating free-air temperature range.

| SYMBOL | PARAMETER |  | RATING | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply voltage |  | -0.5 to +7.0 | V |
| $\mathrm{V}_{\text {IN }}$ | Input voltage | All inputs except B0-B8 | -1.2 to +7.0 | V |
|  |  | $\overline{\mathrm{B0}}$ - $\overline{\mathrm{B}}$ | -1.2 to +3.5 |  |
| IIN | Input current |  | -40 to +5.0 | mA |
| $\mathrm{V}_{\text {OUT }}$ | Voltage applied to output in High output state |  | -0.5 to $+\mathrm{V}_{\text {CC }}$ | V |
| Iout | Current applied to output in Low output state | A0 - A8 | 48 | mA |
|  |  | $\overline{\mathrm{BO}}$ - $\overline{\mathrm{B}}$ | 200 |  |
| TSTG | Storage temperature |  | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |

RECOMMENDED OPERATING CONDITIONS (Industrial)

| SYMBOL | PARAMETER |  | LIMITS |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX |  |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply voltage |  | 4.5 | 5.0 | 5.5 | V |
| $\mathrm{V}_{\mathrm{IH}}$ | High-level input voltage | Except B0-B8 | 2.0 |  |  | V |
|  |  | B0-B8 | 1.62 | 1.55 |  |  |
| $\mathrm{V}_{\mathrm{IL}}$ | Low-level input voltage | Except $\overline{\mathrm{B0}}$ - $\overline{\mathrm{B}} 8$ |  |  | 0.8 | V |
|  |  | $\overline{\mathrm{BO}}$ - $\overline{\mathrm{B}}$ |  |  | 1.47 |  |
| IIK | Input clamp current | Control inputs |  |  | -40 | mA |
|  |  | $\overline{\mathrm{B0}}$ - $\overline{\mathrm{B}}$ \& A0 - A8 |  |  | -18 |  |
| $\mathrm{I}_{\mathrm{OH}}$ | High-level output current | A0-A8 |  |  | -3 | mA |
| IOL | Low-level output current | A0 - A8 |  |  | 24 | mA |
|  |  | $\overline{\text { B0 - B8 }}$ |  |  | 100 |  |
| $I_{\text {I }}$ | Off device input current | $\begin{aligned} & \text { Except } \mathrm{BO}-\mathrm{B8}, \\ & \mathrm{~V}_{\mathrm{I}}=0 \text { to } 5.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}=0 \mathrm{~V} \\ & \hline \end{aligned}$ |  |  | 100 | $\mu \mathrm{A}$ |
| $\mathrm{C}_{\text {OB }}$ | Output capacitance of B port |  |  | 6 | 7 | pF |
| $\mathrm{T}_{\text {amb }}$ | Operating free-air temperature range |  | -40 |  | +85 | ${ }^{\circ} \mathrm{C}$ |

## RECOMMENDED OPERATING CONDITIONS (Commercial)

| SYMBOL | PARAMETER |  | LIMITS |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX |  |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply voltage |  | 4.5 | 5.0 | 5.5 | V |
| $\mathrm{V}_{\mathrm{IH}}$ | High-level input voltage | Except B0-B8 | 2.0 |  |  | V |
|  |  | $\overline{\mathrm{B}}$ - B 8 | 1.62 | 1.55 |  |  |
| $\mathrm{V}_{\mathrm{IL}}$ | Low-level input voltage | Except $\overline{\mathrm{BO}}$ - $\overline{\mathrm{B}}$ |  |  | 0.8 | V |
|  |  | $\overline{\mathrm{B0}}$ - $\overline{\mathrm{B}}$ |  |  | 1.47 |  |
| IIK | Input clamp current | Control inputs |  |  | -40 | mA |
|  |  | $\overline{B 0}-\mathrm{B8}$ \& A0 - A8 |  |  | -18 |  |
| IOH | High-level output current | A0-A8 |  |  | -3 | mA |
| $\mathrm{l}_{\text {OL }}$ | Low-level output current | A0 - A8 |  |  | 24 | mA |
|  |  | $\overline{\mathrm{BO}}$ - B8 |  |  | 100 |  |
| $I_{\text {I }}$ | Off device input current | $\begin{array}{\|l} \hline \text { Except } \overline{\mathrm{BO}}-\overline{\mathrm{B}}, \\ \mathrm{~V}_{\mathrm{I}}=0 \text { to } 5.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}=0 \mathrm{~V} \\ \hline \end{array}$ |  |  | 100 | $\mu \mathrm{A}$ |
| $\mathrm{C}_{\mathrm{OB}}$ | Output capacitance of B port |  |  | 6 | 7 | pF |
| $\mathrm{T}_{\text {amb }}$ | Operating free-air temperature range |  | 0 |  | +70 | ${ }^{\circ} \mathrm{C}$ |

DC ELECTRICAL CHARACTERISTICS (Industrial)
Over recommended operating free-air temperature range unless otherwise noted.

| SYMBOL | PARAMETER |  | TEST CONDITIONS ${ }^{1}$ | LIMITS |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP ${ }^{2}$ | MAX |  |
| $\mathrm{I}_{\mathrm{OH}}$ | High level output current | $\overline{\mathrm{BO}}$ - $\overline{\mathrm{B}}$ |  | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{\mathrm{IL}}=\mathrm{MAX}, \mathrm{V}_{\mathrm{IH}}=\mathrm{MIN}, \mathrm{V}_{\mathrm{OH}}=1.9 \mathrm{~V}$ |  |  | 100 | $\mu \mathrm{A}$ |
| loff | Power-off output current | B0-B8 | $\mathrm{V}_{\mathrm{CC}}=0.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=\mathrm{MAX}, \mathrm{V}_{\mathrm{IH}}=\mathrm{MIN}, \mathrm{V}_{\mathrm{OH}}=1.9 \mathrm{~V}$ |  |  | 200 | $\mu \mathrm{A}$ |
| $\mathrm{V}_{\mathrm{OH}}$ | High-level output voltage | A0-A8 ${ }^{4}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{V}_{\mathrm{IL}}=\mathrm{MAX}, \mathrm{V}_{\mathrm{IH}}=\mathrm{MIN}, \mathrm{I}_{\mathrm{OH}}=-24 \mathrm{~mA}$ | 2.0 |  |  | V |
|  |  |  | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{V}_{\mathrm{IL}}=\mathrm{MAX}, \mathrm{V}_{\mathrm{IH}}=\mathrm{MIN}, \mathrm{I}_{\mathrm{OH}}=-3 \mathrm{~mA}$ | 2.5 | 2.85 |  |  |
| $\mathrm{V}_{\text {OL }}$ | Low-level output voltage | A0-A8 ${ }^{4}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{V}_{\mathrm{IL}}=\mathrm{MAX}, \mathrm{V}_{\mathrm{IH}}=\mathrm{MIN}, \mathrm{I}_{\mathrm{OL}}=24 \mathrm{~mA}$ |  |  | 0.5 | V |
|  |  | B0 - B8 | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{V}_{\mathrm{IL}}=\mathrm{MAX}, \mathrm{V}_{\mathrm{IH}}=\mathrm{MIN}, \mathrm{I}_{\mathrm{OL}}=80 \mathrm{~mA}$ | . 75 | 1.0 | 1.1 |  |
|  |  |  | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{V}_{\mathrm{IL}}=\mathrm{MAX}, \mathrm{V}_{\mathrm{IH}}=\mathrm{MIN}, \mathrm{I}_{\mathrm{OL}}=100 \mathrm{~mA}$ |  |  | 1.15 |  |
|  |  |  | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{V}_{\mathrm{IL}}=\mathrm{MAX}, \mathrm{V}_{\mathrm{IH}}=\mathrm{MIN}, \mathrm{I} \mathrm{IL}=80 \mathrm{~mA}$ |  |  | 1.15 |  |
|  |  |  | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{V}_{\mathrm{IL}}=\mathrm{MAX}, \mathrm{V}_{\mathrm{IH}}=\mathrm{MIN}, \mathrm{IOL}=4 \mathrm{~mA}$ | 0.5 |  |  |  |
| $\mathrm{V}_{\mathrm{IK}}$ | Input clamp voltage | Control pins | $\mathrm{V}_{\text {CC }}=\mathrm{MIN}, \mathrm{I}_{\mathrm{I}}=\mathrm{I}_{\mathrm{IK}}$ |  |  | -0.5 | V |
|  |  | $\begin{array}{\|l\|} \hline \mathrm{A} 0-\mathrm{A} 8 \\ \overline{\mathrm{~B} 0}-\overline{\mathrm{Bn}} \end{array}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{I}_{\mathrm{I}}=-18 \mathrm{~mA}$ |  |  | -1.2 |  |
| 1 | Input current at maximum input voltage | $\begin{array}{\|l\|} \hline \frac{\text { Except }}{\text { B0-B8 }} \\ \hline \end{array}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{\mathrm{I}}=0.5 \mathrm{~V}$ or 5.5 V |  |  | $\pm 50$ | $\mu \mathrm{A}$ |
| $\mathrm{IIH}^{\text {H }}$ | High-level input current | $\begin{array}{\|l\|} \hline \frac{\text { Except }}{\text { B0-B8 }} \\ \hline \end{array}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{\mathrm{I}}=2.7 \mathrm{~V}$ |  |  | 20 | $\mu \mathrm{A}$ |
|  |  | B0-B8 | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{\mathrm{I}}=1.9 \mathrm{~V}$ |  |  | 100 |  |
|  |  |  | $\mathrm{V}_{\text {CC }}=\mathrm{MAX}, \mathrm{V}_{1}=3.5 \mathrm{~V}^{5}$ | 100 |  |  | mA |
| IIL | Low-level input current | $\begin{array}{\|l\|} \hline \frac{\text { Except }}{B 0-B 8} \\ \hline \end{array}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{\mathrm{I}}=0.5 \mathrm{~V}$ |  |  | -20 | $\mu \mathrm{A}$ |
|  |  | $\overline{\mathrm{BO}}-\overline{\mathrm{B}} 8$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{1}=0.75 \mathrm{~V}$ |  |  | -100 |  |
| $\mathrm{I}_{\mathrm{IH}}+\mathrm{I}_{\text {OZH }}$ | Off-state I/O High current | A0-A8 | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{\mathrm{O}}=2.7 \mathrm{~V}$ |  |  | 50 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {IL }}+\mathrm{I}_{\text {OZL }}$ | Off-state I/O Low current | A0-A8 | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{\mathrm{O}}=0.5 \mathrm{~V}$ |  |  | -50 | $\mu \mathrm{A}$ |
| los | Short-circuit output current ${ }^{3}$ | $\begin{array}{\|l} \hline \begin{array}{l} \text { A0 - A8 } \\ \text { only } \end{array} \\ \hline \end{array}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{\mathrm{O}}=0.0 \mathrm{~V}$ | -45 |  | -150 | mA |
| $I_{\text {cc }}$ | Supply current (total) | An to Bn | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}$, outputs Low or High |  | 17 | 30 | mA |
|  |  | $\overline{\mathrm{Bn}}$ to An | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}$, outputs Low |  | 50 | 78 |  |
|  |  | $\overline{\mathrm{Bn}}$ to An | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}$, outputs High |  | 25 | 45 |  |
|  |  | $\mathrm{I}_{\text {ccz }}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}$, outputs 3-State |  | 28 | 50 |  |
|  |  | Worst case | $\mathrm{V}_{C C}=\mathrm{MAX}$, all A and B outputs on |  | 50 | 78 |  |

## NOTES:

1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operation conditions for the applicable type.
2. All typical values are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{amb}}=25^{\circ} \mathrm{C}$.
3. Not more than one output should be shorted at a time. For testing los, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, Ios tests should be performed last.
4. Due to test equipment limitations, actual test conditions are $\mathrm{V}_{\mathrm{IH}}=1.8 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{IL}}=1.3 \mathrm{~V}$ for the B side.
5. For B port input voltage between 3 and 5 volts $\mathrm{I}_{\mathrm{IH}}$ will be greater than $100 \mu \mathrm{~A}$, but the parts will continue to function normally.
6. $\overline{\mathrm{BO}}-\overline{\mathrm{B}} \mathrm{c}$ clamps remain active for a minimum of 80 ns following a High-to-Low transition.
7. Temperature range: 0 to $+85^{\circ} \mathrm{C}$.
8. Temperature range: -40 to $0^{\circ} \mathrm{C}$.

## DC ELECTRICAL CHARACTERISTICS (Commercial)

Over recommended operating free-air temperature range unless otherwise noted.

| SYMBOL | PARAMETER |  | TEST CONDITIONS ${ }^{1}$ | LIMITS |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP² | MAX |  |
| $\mathrm{I}_{\mathrm{OH}}$ | High level output current | B0-B8 |  | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{\mathrm{IL}}=\mathrm{MAX}, \mathrm{V}_{\mathrm{IH}}=\mathrm{MIN}, \mathrm{V}_{\mathrm{OH}}=1.9 \mathrm{~V}$ |  |  | 100 | $\mu \mathrm{A}$ |
| IOFF | Power-off output current | B0 - B8 | $\mathrm{V}_{\mathrm{CC}}=0.0 \mathrm{~V}, \mathrm{~V}_{\text {IL }}=\mathrm{MAX}, \mathrm{V}_{\text {IH }}=\mathrm{MIN}, \mathrm{V}_{\mathrm{OH}}=1.9 \mathrm{~V}$ |  |  | 100 | $\mu \mathrm{A}$ |
| $\mathrm{V}_{\mathrm{OH}}$ | High-level output voltage | A0-A8 ${ }^{4}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{V}_{\mathrm{IL}}=\mathrm{MAX}, \mathrm{V}_{\mathrm{IH}}=\mathrm{MIN}, \mathrm{I}_{\mathrm{OH}}=-24 \mathrm{~mA}$ | 2.0 |  |  | V |
|  |  |  | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{V}_{\text {IL }}=\mathrm{MAX}, \mathrm{V}_{\text {IH }}=\mathrm{MIN}, \mathrm{I}_{\mathrm{OH}}=-3 \mathrm{~mA}$ | 2.5 | 2.85 |  |  |
| $\mathrm{V}_{\text {OL }}$ | Low-level output voltage | A0-A8 ${ }^{4}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{V}_{\mathrm{IL}}=\mathrm{MAX}, \mathrm{V}_{\text {IH }}=\mathrm{MIN}, \mathrm{I}_{\mathrm{OL}}=24 \mathrm{~mA}$ |  |  | 0.5 | V |
|  |  | $\overline{\mathrm{B0}}$ - $\overline{\mathrm{B}} 8$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{V}_{\mathrm{IL}}=\mathrm{MAX}, \mathrm{V}_{\mathrm{IH}}=\mathrm{MIN}, \mathrm{I}_{\mathrm{OL}}=80 \mathrm{~mA}$ | . 75 | 1.0 | 1.1 |  |
|  |  |  | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{V}_{\mathrm{IL}}=\mathrm{MAX}, \mathrm{V}_{\mathrm{IH}}=\mathrm{MIN}, \mathrm{I}_{\mathrm{OL}}=100 \mathrm{~mA}$ |  |  | 1.15 |  |
|  |  |  | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{V}_{\mathrm{IL}}=\mathrm{MAX}, \mathrm{V}_{\mathrm{IH}}=\mathrm{MIN}, \mathrm{I}_{\mathrm{OL}}=4 \mathrm{~mA}$ | 0.5 |  |  |  |
| $\mathrm{V}_{\text {IK }}$ | Input clamp voltage | Control pins | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{I}_{\mathrm{I}}=\mathrm{I}_{\mathrm{IK}}$ |  |  | -0.5 | V |
|  |  | $\begin{aligned} & \mathrm{A} 0-\mathrm{A} 8 \\ & \mathrm{B0}-\overline{\mathrm{Bn}} \end{aligned}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{I}_{\mathrm{I}}=-18 \mathrm{~mA}$ |  |  | -1.2 |  |
| 1 | Input current at maximum input voltage | $\begin{array}{\|l\|} \hline \frac{\text { Except }}{B 0-B 8} \\ \hline \end{array}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{\mathrm{I}}=0.0 \mathrm{~V}$ or 5.5 V |  |  | $\pm 50$ | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathbf{H}}$ | High-level input current | $\begin{array}{\|l} \frac{\text { Except }}{B 0-B 8} \end{array}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{1}=2.7 \mathrm{~V}$ |  |  | 20 | $\mu \mathrm{A}$ |
|  |  | B0-B8 | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{1}=1.9 \mathrm{~V}$ |  |  | 100 |  |
|  |  |  | $\mathrm{V}_{\text {CC }}=\mathrm{MAX}, \mathrm{V}_{\mathrm{I}}=3.5 \mathrm{~V} 5$ | 100 |  |  | mA |
| IIL | Low-level input current | $\begin{array}{\|l} \frac{\text { Except }}{B 0-B 8} \\ \hline \end{array}$ | $\mathrm{V}_{C C}=\mathrm{MAX}, \mathrm{V}_{1}=0.5 \mathrm{~V}$ |  |  | -20 | $\mu \mathrm{A}$ |
|  |  | $\overline{\mathrm{B0}}$ - B 8 | $\mathrm{V}_{\text {CC }}=\mathrm{MAX}, \mathrm{V}_{1}=0.75 \mathrm{~V}$ |  |  | -100 |  |
| $\mathrm{I}_{\mathrm{H}}+\mathrm{I}_{\text {OZH }}$ | Off-state I/O High current | A0 - A8 | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{\mathrm{O}}=2.7 \mathrm{~V}$ |  |  | 50 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {IL }}+\mathrm{I}_{\text {OZL }}$ | Off-state I/O Low current | A0 - A8 | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{\mathrm{O}}=0.5 \mathrm{~V}$ |  |  | -50 | $\mu \mathrm{A}$ |
| los | Short-circuit output current ${ }^{3}$ | A0 - A8 only | $\mathrm{V}_{C C}=\mathrm{MAX}, \mathrm{V}_{\mathrm{O}}=0.0 \mathrm{~V}$ | -45 |  | -150 | mA |
| Icc | Supply current (total) | An to Bn | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}$, outputs Low or High |  | 17 | 30 | mA |
|  |  | $\overline{\mathrm{Bn}}$ to An | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}$, outputs Low |  | 50 | 78 |  |
|  |  | $\overline{\mathrm{Bn}}$ to An | $\mathrm{V}_{\text {CC }}=$ MAX, outputs High |  | 25 | 45 |  |
|  |  | $\mathrm{I}_{\text {CCz }}$ | $\mathrm{V}_{\text {CC }}=$ MAX, outputs 3-State |  | 28 | 50 |  |
|  |  | Worst case | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}$, all A and B outputs on |  | 50 | 78 |  |

## NOTES:

1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operation conditions for the applicable type.
2. All typical values are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{amb}}=25^{\circ} \mathrm{C}$.
3. Not more than one output should be shorted at a time. For testing los, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, los tests should be performed last.
4. Due to test equipment limitations, actual test conditions are $\mathrm{V}_{\mathrm{IH}}=1.8 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{IL}}=1.3 \mathrm{~V}$ for the B side.
5. For B port input voltage between 3 and 5 volts $\mathrm{I}_{\mathrm{IH}}$ will be greater than $100 \mu \mathrm{~A}$, but the parts will continue to function normally.
6. $\mathrm{BO}-\mathrm{B} 8$ clamps remain active for a minimum of 80 ns following a High-to-Low transition.

## LIVE INSERTION SPECIFICATIONS

| SYMBOL | PARAMETER |  | LIMITS |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | NOM | MAX |  |
| $\mathrm{V}_{\text {BIASV }}$ | Bias pin voltage | $\mathrm{V}_{\mathrm{CC}}=0$ to $5.25 \mathrm{~V}, \mathrm{Bn}=0$ to 2.0 V | 4.5 |  | 5.5 | V |
| IBIASV | Bias pin DC current | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=0 \text { to } 4.75 \mathrm{~V}, \mathrm{Bn}=0 \text { to } 2.0 \mathrm{~V}, \\ & \text { Bias } \mathrm{V}=4.5 \text { to } 5.5 \mathrm{~V} \end{aligned}$ |  |  | 1 | mA |
|  |  | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=4.5 \text { to } 5.5 \mathrm{~V}, \mathrm{Bn}=0 \text { to } 2.0 \mathrm{~V}, \\ & \text { Bias } \mathrm{V}=4.5 \text { to } 5.5 \mathrm{~V} \end{aligned}$ |  |  | 10 | $\mu \mathrm{A}$ |
| $V_{\text {Bn }}$ | Bus voltage during prebias | $\overline{\mathrm{B0}}-\overline{\mathrm{B} 8}=0 \mathrm{~V}$, Bias V $=5.0 \mathrm{~V}$ | 1.62 |  | 2.1 | V |
| ILM | Fall current during prebias | $\overline{\mathrm{BO}}-\overline{\mathrm{B}}=2 \mathrm{~V}$, Bias $\mathrm{V}=4.5$ to 5.5 V | 1 |  |  | $\mu \mathrm{A}$ |
| IHM | Rise current during prebias | $\overline{\mathrm{BO}}-\overline{\mathrm{B}} 8=1 \mathrm{~V}$, Bias $\mathrm{V}=4.5$ to 5.5 V | -1 |  |  | $\mu \mathrm{A}$ |
| I-Bn PEAK | Peak bus current during insertion | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=0 \text { to } 5.25 \mathrm{~V}, \mathrm{BO}-\mathrm{B8}=0 \text { to } 2.0 \mathrm{~V}, \\ & \text { Bias } \mathrm{V}=4.5 \text { to } 5.5 \mathrm{~V}, \mathrm{OEB0}=0.8 \mathrm{~V}, \mathrm{t}_{\mathrm{r}}=2 \mathrm{~ns} \end{aligned}$ |  |  | 10 | mA |
| Ioloff | Power up current | $\mathrm{V}_{\mathrm{CC}}=0$ to $5.25 \mathrm{~V}, \mathrm{OEB0}=0.8 \mathrm{~V}$ |  |  | 100 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\mathrm{CC}}=0$ to 2.2V, OEB0 $=0$ to 5 V |  |  | 100 |  |
| $\mathrm{t}_{\mathrm{GR}}$ | Input glitch rejection | $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}$ |  | 1.35 | 1.0 | ns |

## AC ELECTRICAL CHARACTERISTICS (Industrial)

| SYMBOL | PARAMETER | TEST CONDITION | A PORT LIMITS |  |  |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\begin{gathered} \mathrm{T}_{\mathrm{amb}}=+25^{\circ} \mathrm{C}, \mathrm{~V}_{\mathrm{Cc}}=5 \mathrm{~V}, \\ \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=500 \Omega \end{gathered}$ |  |  | $\begin{gathered} \mathrm{T}_{\mathrm{amb}}=-40 \text { to }+85^{\circ} \mathrm{C}, \\ \mathrm{~V}_{\mathrm{CC}}=5 \mathrm{~V} \pm 10 \%, \\ \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=500 \Omega \end{gathered}$ |  |  |
|  |  |  | MIN | TYP | MAX | MIN | MAX |  |
| $\mathrm{f}_{\text {MAX }}$ | Maximum clock frequency | Waveform 4 | 120 | 150 |  | 100 |  | MHz |
| $\begin{aligned} & t_{\text {PLH }} \\ & t_{\text {PHL }} \\ & \hline \end{aligned}$ | Propagation delay (thru mode) $\overline{\mathrm{Bn}}$ to An | Waveform 1, 2 | $\begin{aligned} & \hline 2.5 \\ & 2.4 \end{aligned}$ | $\begin{aligned} & 4.4 \\ & 4.2 \end{aligned}$ | $\begin{aligned} & 5.9 \\ & 5.5 \\ & \hline \end{aligned}$ | $\begin{aligned} & 2.3 \\ & 2.4 \\ & \hline \end{aligned}$ | $\begin{aligned} & 7.0 \\ & 6.2 \end{aligned}$ | ns |
| $\begin{aligned} & \hline \text { tPLH } \\ & t_{\text {PHL }} \end{aligned}$ | Propagation delay (transparent latch) Bn to An | Waveform 1, 2 | $\begin{aligned} & \hline 2.9 \\ & 2.8 \end{aligned}$ | $\begin{aligned} & 4.6 \\ & 4.3 \end{aligned}$ | $\begin{aligned} & \hline 6.2 \\ & 5.9 \end{aligned}$ | $\begin{aligned} & 2.7 \\ & 2.5 \end{aligned}$ | $\begin{aligned} & \hline 7.1 \\ & 7.0 \end{aligned}$ | ns |
| $\begin{aligned} & \hline \text { tPLH } \\ & t_{\text {PHLL }} \end{aligned}$ | Propagation delay LCBA to An | Waveform 1, 2 | $\begin{aligned} & \hline 2.6 \\ & 2.4 \end{aligned}$ | $\begin{aligned} & \hline 4.1 \\ & 4.7 \end{aligned}$ | $\begin{aligned} & \hline 5.5 \\ & 6.1 \end{aligned}$ | $\begin{aligned} & 2.0 \\ & 2.0 \\ & \hline \end{aligned}$ | $\begin{aligned} & \hline 6.2 \\ & 6.8 \end{aligned}$ | ns |
| $\begin{aligned} & \text { tpLH } \\ & t_{\text {PHL }} \end{aligned}$ | Propagation delay SELO or SEL1 to An | Waveform 1, 2 | $\begin{aligned} & 1.5 \\ & 1.7 \end{aligned}$ | $\begin{aligned} & \hline 3.8 \\ & 3.9 \end{aligned}$ | $\begin{aligned} & 5.2 \\ & 6.0 \end{aligned}$ | $\begin{aligned} & 1.2 \\ & 1.5 \end{aligned}$ | $\begin{aligned} & \hline 6.2 \\ & 6.5 \end{aligned}$ | ns |
| $\begin{aligned} & \mathrm{tpZH} \\ & \mathrm{tpl}^{2} \end{aligned}$ | Output enable time from High or Low OEA to An | Waveform 5, 6 | $\begin{aligned} & 2.1 \\ & 2.0 \\ & \hline \end{aligned}$ | $\begin{aligned} & \hline 3.5 \\ & 3.8 \end{aligned}$ | $\begin{aligned} & 4.8 \\ & 5.3 \end{aligned}$ | $\begin{aligned} & 1.8 \\ & 1.7 \\ & \hline \end{aligned}$ | $\begin{aligned} & \hline 6.0 \\ & 6.3 \end{aligned}$ | ns |
| $\begin{aligned} & \text { tpHZ } \\ & \mathrm{t}_{\mathrm{PLLZ}} \end{aligned}$ | Output disable time to High or Low OEA to An | Waveform 5, 6 | $\begin{aligned} & \hline 1.9 \\ & 1.7 \end{aligned}$ | $\begin{aligned} & \hline 3.4 \\ & 3.2 \end{aligned}$ | $\begin{aligned} & 4.8 \\ & 4.8 \end{aligned}$ | $\begin{aligned} & \hline 1.6 \\ & 1.5 \end{aligned}$ | $\begin{aligned} & \hline 5.5 \\ & 5.5 \end{aligned}$ | ns |
| $\begin{aligned} & \mathrm{t}_{\mathrm{T} \mathrm{LH}} \\ & \mathrm{t}_{\mathrm{TH} \mathrm{HL}} \end{aligned}$ | Output transition time, An Port $10 \%$ to $90 \%, 90 \%$ to $10 \%$ | Test Circuit and Waveforms |  |  |  | $\begin{aligned} & 3.0 \\ & 1.7 \end{aligned}$ | $\begin{aligned} & 7.5 \\ & 4.0 \end{aligned}$ | ns |
| tsk(0) | Output to output skew for multiple channels ${ }^{1}$ | Waveform 3 |  | 0.5 | 1.0 |  | 1.5 | ns |
| ${ }^{\text {tsk }}$ (p) | $\begin{array}{\|l} \hline \text { Pulse skew }{ }^{2} \\ \left.\right\|_{\text {tPHL }}-\left.t_{\text {PLH }}\right\|_{\text {MAX }} \end{array}$ | Waveform 2 |  | 0.5 | 1.0 |  | 1.0 | ns |

## NOTES:

1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operation conditions for the applicable type.
2. All typical values are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{amb}}=25^{\circ} \mathrm{C}$.
3. Not more than one output should be shorted at a time. For testing los, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, los tests should be performed last.
4. Due to test equipment limitations, actual test conditions are $\mathrm{V}_{\mathrm{IH}}=1.8 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{IL}}=1.3 \mathrm{~V}$ for the B side.
5. For B port input voltage between 3 and 5 volts $\mathrm{I}_{\mid H}$ will be greater than $100 \mu \mathrm{~A}$, but the parts will continue to function normally.
6. $\overline{B O}-\overline{\mathrm{B}}$ clamps remain active for a minimum of 80 ns following a High-to-Low transition.

## AC ELECTRICAL CHARACTERISTICS (Industrial)

| SYMBOL | PARAMETER | TEST CONDITION | B PORT LIMITS |  |  |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\begin{gathered} \mathrm{T}_{\mathrm{amb}}=+25^{\circ} \mathrm{C}, \mathrm{~V}_{\mathrm{CC}}=5 \mathrm{~V}, \\ \mathrm{C}_{\mathrm{D}}=30 \mathrm{pF}, \mathrm{R}_{\mathrm{U}}=16.5 \Omega \end{gathered}$ |  |  | $\begin{gathered} \mathrm{T}_{\mathrm{amb}}=-40 \text { to }+85^{\circ} \mathrm{C}, \\ \mathrm{~V}_{\mathrm{cc}}=5 \mathrm{~V} \pm 10 \%, \\ \mathrm{C}_{\mathrm{D}}=30 \mathrm{pF}, \mathrm{R}_{\mathrm{U}}=16.5 \Omega \end{gathered}$ |  |  |
|  |  |  | MIN | TYP | MAX | MIN | MAX |  |
| $\begin{aligned} & \hline \mathrm{t}_{\mathrm{PLH}} \\ & \mathrm{t}_{\mathrm{PHL}} \\ & \hline \end{aligned}$ | Propagation delay (thru mode) An to Bn | Waveform 1, 2 | $\begin{aligned} & \hline 1.0 \\ & 1.0 \\ & \hline \end{aligned}$ | $\begin{aligned} & 3.0 \\ & 2.7 \\ & \hline \end{aligned}$ | $\begin{aligned} & 5.0 \\ & 4.0 \\ & \hline \end{aligned}$ | $\begin{aligned} & \hline 1.5 \\ & 1.5 \\ & \hline \end{aligned}$ | $\begin{aligned} & 5.7 \\ & 4.5 \\ & \hline \end{aligned}$ | ns |
| $\begin{aligned} & \mathrm{t}_{\mathrm{PLH}} \\ & \mathrm{t}_{\mathrm{PHL}} \\ & \hline \end{aligned}$ | Propagation delay (transparent latch) An to Bn | Waveform 1, 2 | $\begin{aligned} & 1.0 \\ & 1.0 \\ & \hline \end{aligned}$ | $\begin{aligned} & 3.2 \\ & 3.1 \\ & \hline \end{aligned}$ | $\begin{aligned} & \hline 5.0 \\ & 4.2 \end{aligned}$ | $\begin{aligned} & 1.5 \\ & 1.5 \\ & \hline \end{aligned}$ | $\begin{aligned} & 5.5 \\ & 5.0 \\ & \hline \end{aligned}$ | ns |
| $\begin{aligned} & \text { tpLH } \\ & t_{\text {PHL }} \end{aligned}$ | Propagation delay LCAB to Bn | Waveform 1, 2 | $\begin{aligned} & 2.0 \\ & 1.5 \end{aligned}$ | $\begin{aligned} & 4.0 \\ & 4.0 \end{aligned}$ | $\begin{aligned} & \hline 5.5 \\ & 5.5 \end{aligned}$ | $\begin{aligned} & 1.5 \\ & 1.5 \end{aligned}$ | $\begin{aligned} & 6.5 \\ & 6.0 \end{aligned}$ | ns |
| $\begin{aligned} & \mathrm{t}_{\mathrm{PLH}} \\ & \mathrm{t}_{\mathrm{PHL}} \\ & \hline \end{aligned}$ | Propagation delay SEL0 or SEL1 to Bn | Waveform 1, 2 | $\begin{aligned} & 2.0 \\ & 1.5 \\ & \hline \end{aligned}$ | $\begin{aligned} & 3.5 \\ & 2.3 \end{aligned}$ | $\begin{aligned} & 5.5 \\ & 4.5 \\ & \hline \end{aligned}$ | $\begin{aligned} & 2.0 \\ & 1.0 \\ & \hline \end{aligned}$ | $\begin{aligned} & \hline 6.1 \\ & 5.5 \\ & \hline \end{aligned}$ | ns |
| $\begin{aligned} & \text { tpzH } \\ & \text { tpZL } \\ & \hline \end{aligned}$ | Enable/disable time OEB0 or OEB1 to Bn | Waveform 1, 2 | $\begin{aligned} & \hline 1.5 \\ & 1.2 \\ & \hline \end{aligned}$ | $\begin{aligned} & 3.0 \\ & 2.4 \\ & \hline \end{aligned}$ | $\begin{aligned} & 5.0 \\ & 4.5 \\ & \hline \end{aligned}$ | $\begin{aligned} & \hline 1.0 \\ & 1.0 \\ & \hline \end{aligned}$ | $\begin{aligned} & 5.7 \\ & 5.5 \\ & \hline \end{aligned}$ | ns |
| $\begin{aligned} & \mathrm{t}_{\mathrm{T} L \mathrm{H}} \\ & \mathrm{t}_{\mathrm{THL}} \end{aligned}$ | Output transition time, Bn Port (1.3V to 1.8V) | Test Circuit and Waveforms | $\begin{aligned} & 1.0 \\ & 0.6 \end{aligned}$ |  | $\begin{aligned} & 2.0 \\ & 3.0 \end{aligned}$ | $\begin{aligned} & \hline 0.9 \\ & 0.6 \end{aligned}$ | $\begin{aligned} & 3.0 \\ & 3.0 \end{aligned}$ | ns |
| ${ }^{\text {tsk }}$ (0) | Output to output skew for multiple channels ${ }^{1}$ | Waveform 3 | 1.0 | 0.4 |  | 1.6 | 1.6 | ns |
| ${ }^{\text {tsk }}$ (p) | Pulse skew ${ }^{2}$ $\left.\right\|_{\text {tPHL }}-\left.t_{\text {PLH }}\right\|_{\text {MAX }}$ | Waveform 2 |  | 0.3 | 1.0 |  | 1.5 | ns |

## NOTES:

 HL . Skew times are valid only under same test conditions (temperature, $\mathrm{V}_{\mathrm{CC}}$, loading, etc.).
2. $t_{S k}(p)$ is used to quantify duty cycle characteristics. In essence it compares the input signal duty cycle to the corresponding output signal duty cycle ( 50 MHz input frequency and $50 \%$ duty cycle, tested on data paths only).

## AC ELECTRICAL CHARACTERISTICS (Commercial)

| SYMBOL | PARAMETER | TEST CONDITION | A PORT LIMITS |  |  |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\begin{gathered} \mathrm{T}_{\mathrm{amb}}=+25^{\circ} \mathrm{C}, \mathrm{~V}_{\mathrm{CC}}=5 \mathrm{~V}, \\ \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=500 \Omega \end{gathered}$ |  |  | $\begin{gathered} \mathrm{T}_{\mathrm{amb}}=0 \text { to }+70^{\circ} \mathrm{C}, \\ \mathrm{~V}_{\mathrm{cc}}=5 \mathrm{~V} \pm 10 \%, \\ \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=500 \Omega \end{gathered}$ |  |  |
|  |  |  | MIN | TYP | MAX | MIN | MAX |  |
| $\mathrm{f}_{\text {MAX }}$ | Maximum clock frequency | Waveform 4 | 120 | 150 |  | 100 |  | MHz |
| $\begin{aligned} & \hline \text { tpLH } \\ & t_{\text {tPHL }} \end{aligned}$ | Propagation delay (thru mode) <br> $\overline{B n}$ to An | Waveform 1, 2 | $\begin{aligned} & 2.5 \\ & 2.4 \end{aligned}$ | $\begin{aligned} & \hline 4.4 \\ & 4.2 \end{aligned}$ | $\begin{aligned} & 5.9 \\ & 5.5 \end{aligned}$ | $\begin{aligned} & \hline 2.3 \\ & 2.4 \end{aligned}$ | $\begin{aligned} & \hline 6.6 \\ & 5.9 \end{aligned}$ | ns |
| $\begin{aligned} & \hline \text { tpLH } \\ & t_{\text {PHL }} \end{aligned}$ | Propagation delay (transparent latch) Bn to An | Waveform 1, 2 | $\begin{aligned} & 2.9 \\ & 2.8 \end{aligned}$ | $\begin{aligned} & 4.6 \\ & 4.3 \end{aligned}$ | $\begin{aligned} & 6.2 \\ & 5.9 \end{aligned}$ | $\begin{aligned} & 2.7 \\ & 2.5 \end{aligned}$ | $\begin{aligned} & 7.0 \\ & 6.5 \end{aligned}$ | ns |
| $\begin{aligned} & \hline \text { tpLH } \\ & \mathrm{t}_{\mathrm{PHL}} \\ & \hline \end{aligned}$ | Propagation delay LCBA to An | Waveform 1, 2 | $\begin{aligned} & \hline 2.6 \\ & 2.4 \\ & \hline \end{aligned}$ | $\begin{aligned} & 4.1 \\ & 4.7 \end{aligned}$ | $\begin{aligned} & \hline 5.5 \\ & 6.1 \end{aligned}$ | $\begin{aligned} & \hline 2.0 \\ & 2.0 \\ & \hline \end{aligned}$ | $\begin{aligned} & \hline 6.0 \\ & 6.5 \\ & \hline \end{aligned}$ | ns |
| $\begin{aligned} & \text { tPLH } \\ & t_{\text {tPHL }} \\ & \hline \end{aligned}$ | Propagation delay SELO or SEL1 to An | Waveform 1, 2 | $\begin{aligned} & 1.5 \\ & 1.7 \end{aligned}$ | $\begin{aligned} & \hline 3.8 \\ & 3.9 \\ & \hline \end{aligned}$ | $\begin{aligned} & 5.2 \\ & 6.0 \end{aligned}$ | $\begin{aligned} & 1.2 \\ & 1.5 \end{aligned}$ | $\begin{aligned} & 6.0 \\ & 6.5 \end{aligned}$ | ns |
| $\begin{aligned} & \hline \mathrm{t}_{\mathrm{pZH}} \\ & \mathrm{t}_{\text {PZL }} \end{aligned}$ | Output enable time from High or Low OEA to An | Waveform 5, 6 | $\begin{aligned} & 2.1 \\ & 2.0 \end{aligned}$ | $\begin{aligned} & \hline 3.5 \\ & 3.8 \\ & \hline \end{aligned}$ | $\begin{aligned} & 4.8 \\ & 5.3 \end{aligned}$ | $\begin{aligned} & \hline 1.8 \\ & 1.7 \end{aligned}$ | $\begin{aligned} & 5.8 \\ & 6.0 \end{aligned}$ | ns |
| $\begin{aligned} & \hline \mathrm{t}_{\mathrm{PHZ}} \\ & \mathrm{t}_{\mathrm{pLLZ}} \end{aligned}$ | Output disable time to High or Low OEA to An | Waveform 5, 6 | $\begin{aligned} & 1.9 \\ & 1.7 \end{aligned}$ | $\begin{aligned} & 3.4 \\ & 3.2 \end{aligned}$ | $\begin{aligned} & \hline 4.8 \\ & 4.8 \end{aligned}$ | $\begin{aligned} & \hline 1.6 \\ & 1.5 \end{aligned}$ | $\begin{aligned} & \hline 5.4 \\ & 5.4 \end{aligned}$ | ns |
| $\begin{aligned} & \mathrm{t}_{\mathrm{T} L \mathrm{H}} \\ & \mathrm{t}_{\mathrm{THL}} \end{aligned}$ | Output transition time, An Port $10 \%$ to $90 \%, 90 \%$ to $10 \%$ | Test Circuit and Waveforms |  |  |  | $\begin{aligned} & \hline 2.0 \\ & 1.0 \end{aligned}$ | $\begin{aligned} & 7.5 \\ & 3.5 \end{aligned}$ | ns |
| ${ }_{\text {t }}^{\text {SK }}$ (0) | Output to output skew for multiple channels ${ }^{1}$ | Waveform 3 |  | 0.5 | 1.0 |  | 1.5 | ns |
| $t_{\text {Sk }}(\mathrm{p})$ | Pulse skew ${ }^{2}$ $\left.\right\|_{\mathrm{t}_{\text {PHL }}}-\left.\mathrm{t}_{\text {PLH }}\right\|_{\text {MAX }}$ | Waveform 2 |  | 0.5 | 1.0 |  | 1.0 | ns |

## NOTES:

 Skew times are valid only under same test conditions (temperature, $\mathrm{V}_{\mathrm{CC}}$, loading, etc.).
2. $\mathrm{t}_{\mathrm{SK}}(\mathrm{p})$ is used to quantify duty cycle characteristics. In essence it compares the input signal duty cycle to the corresponding output signal duty cycle ( 50 MHz input frequency and $50 \%$ duty cycle, tested on data paths only).

## AC ELECTRICAL CHARACTERISTICS (Commercial)

| SYMBOL | PARAMETER | TEST CONDITION | B PORT LIMITS |  |  |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\begin{gathered} \mathrm{T}_{\mathrm{amb}}=+25^{\circ} \mathrm{C}, \mathrm{~V}_{\mathrm{CC}}=5 \mathrm{~V}, \\ \mathrm{C}_{\mathrm{D}}=30 \mathrm{pF}, \mathrm{R}_{\mathrm{U}}=16.5 \Omega \end{gathered}$ |  |  | $\begin{gathered} \mathrm{T}_{\mathrm{amb}}=0 \text { to }+70^{\circ} \mathrm{C}, \\ \mathrm{~V}_{\mathrm{cc}}=5 \mathrm{~V} \pm 10 \%, \\ \mathrm{C}_{\mathrm{D}}=30 \mathrm{pF}, \mathrm{R}_{\mathrm{U}}=16.5 \Omega \end{gathered}$ |  |  |
|  |  |  | MIN | TYP | MAX | MIN | MAX |  |
| $\begin{aligned} & \hline \mathrm{t}_{\mathrm{PLH}} \\ & \mathrm{t}_{\mathrm{PHL}} \\ & \hline \end{aligned}$ | Propagation delay (thru mode) An to Bn | Waveform 1, 2 | $\begin{aligned} & 1.0 \\ & 1.0 \end{aligned}$ | $\begin{aligned} & 3.0 \\ & 2.7 \\ & \hline \end{aligned}$ | $\begin{aligned} & \hline 5.0 \\ & 4.0 \end{aligned}$ | $\begin{aligned} & \hline 1.0 \\ & 0.5 \\ & \hline \end{aligned}$ | $\begin{aligned} & 5.5 \\ & 4.5 \\ & \hline \end{aligned}$ | ns |
| $\begin{aligned} & \text { tpLH } \\ & \text { tol } \end{aligned}$ | Propagation delay (transparent latch) An to Bn | Waveform 1, 2 | $\begin{aligned} & 1.0 \\ & 1.0 \end{aligned}$ | $\begin{aligned} & 3.2 \\ & 3.1 \end{aligned}$ | $\begin{aligned} & 5.0 \\ & 4.2 \end{aligned}$ | $\begin{aligned} & 1.0 \\ & 0.8 \end{aligned}$ | $\begin{aligned} & 5.5 \\ & 4.5 \end{aligned}$ | ns |
| $\begin{aligned} & \text { tpLH } \\ & t_{\text {PHLL }} \\ & \hline \end{aligned}$ | Propagation delay LCAB to Bn | Waveform 1, 2 | $\begin{aligned} & 2.0 \\ & 1.5 \end{aligned}$ | $\begin{aligned} & 4.0 \\ & 4.0 \\ & \hline \end{aligned}$ | $\begin{aligned} & 5.5 \\ & 5.5 \end{aligned}$ | $\begin{aligned} & 1.5 \\ & 1.0 \\ & \hline \end{aligned}$ | $\begin{aligned} & 6.0 \\ & 6.0 \end{aligned}$ | ns |
| $\begin{aligned} & \text { tpLH } \\ & \text { tpHu } \end{aligned}$ | Propagation delay SEL0 or SEL1 to Bn | Waveform 1, 2 | $\begin{aligned} & 2.0 \\ & 1.5 \\ & \hline \end{aligned}$ | $\begin{aligned} & 3.5 \\ & 2.3 \end{aligned}$ | $\begin{aligned} & 5.5 \\ & 4.5 \end{aligned}$ | $\begin{aligned} & \hline 2.0 \\ & 1.0 \end{aligned}$ | $\begin{aligned} & 6.0 \\ & 5.0 \end{aligned}$ | ns |
| $\begin{aligned} & \text { tpzH } \\ & \text { tpZL } \\ & \hline \end{aligned}$ | Enable/disable time | Waveform 1, 2 | $\begin{aligned} & 1.5 \\ & 1.5 \\ & \hline \end{aligned}$ | $\begin{aligned} & 3.0 \\ & 2.4 \\ & \hline \end{aligned}$ | $\begin{aligned} & 5.0 \\ & 4.5 \\ & \hline \end{aligned}$ | $\begin{aligned} & \hline 1.0 \\ & 0.8 \\ & \hline \end{aligned}$ | $\begin{aligned} & 5.5 \\ & 5.5 \\ & \hline \end{aligned}$ | ns |
| $\begin{aligned} & \mathrm{t}_{\mathrm{T} L \mathrm{H}} \\ & \mathrm{t}_{\mathrm{THL}} \end{aligned}$ | Output transition time, Bn Port ( 1.3 V to 1.8 V ) | Test Circuit and Waveforms | $\begin{aligned} & 1.0 \\ & 0.6 \end{aligned}$ |  | $\begin{aligned} & \hline 2.0 \\ & 3.0 \end{aligned}$ | $\begin{aligned} & \hline 1.0 \\ & 0.6 \end{aligned}$ | $\begin{aligned} & \hline 2.3 \\ & 2.3 \end{aligned}$ | ns |
| ${ }^{\text {tsk }}$ (0) | Output to output skew for multiple channels ${ }^{1}$ | Waveform 3 |  | 0.4 | 1.0 |  | 1.6 | ns |
| $\mathrm{t}_{\text {Sk }}(\mathrm{p})$ | $\left.\begin{array}{\|l\|} \hline \text { Pulse skew }{ }^{2} \\ \text { t }_{\text {PHLL }}-\text { t }_{\text {PLH }} \end{array}\right\|_{\text {MAX }}$ | Waveform 2 |  | 0.3 | 1.0 |  | 1.5 | ns |

NOTES:

1. It $t_{\text {PN }}$ actual - tpMactual |for any data input to output path compared to any other data input to output path where N and M are either LH or HL . Skew times are valid only under same test conditions (temperature, $\mathrm{V}_{\mathrm{CC}}$, loading, etc.).
2. $\mathrm{t}_{\mathrm{SK}}(\mathrm{p})$ is used to quantify duty cycle characteristics. In essence it compares the input signal duty cycle to the corresponding output signal duty cycle ( 50 MHz input frequency and $50 \%$ duty cycle, tested on data paths only).

## AC SETUP REQUIREMENTS (Industrial)

| SYMBOL | PARAMETER | TEST CONDITION | LIMITS |  |  |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\mathrm{T}_{\mathrm{amb}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$, |  |  | $\begin{gathered} \mathrm{T}_{\mathrm{amb}}=-40 \text { to }+85^{\circ} \mathrm{C}, \\ \mathrm{~V}_{\mathrm{CC}}=5 \mathrm{~V} \pm 10 \%, \end{gathered}$ |  |  |
|  |  |  | $\begin{gathered} C_{L}=50 \mathrm{pF}(A \text { side }) / C_{D}=30 \mathrm{pF} \text { ( } \mathrm{B} \text { side) } \\ R_{\mathrm{L}}=500 \Omega \text { (A side) } / \mathrm{R}_{\mathrm{U}}=16.5 \Omega \text { (B side) } \end{gathered}$ |  |  |  |  |  |
|  |  |  | MIN | TYP | MAX | MIN | MAX |  |
| $\begin{aligned} & \mathrm{t}_{\mathrm{s}}(\mathrm{H}) \\ & \mathrm{t}_{\mathrm{s}}(\mathrm{~L}) \end{aligned}$ | Setup time <br> An to LCAB | Waveform 4 | $\begin{aligned} & 1.0 \\ & 1.0 \end{aligned}$ |  |  | $\begin{aligned} & 1.5 \\ & 1.0 \\ & \hline \end{aligned}$ |  | ns |
| $\begin{aligned} & \hline \mathrm{th}_{\mathrm{h}}(\mathrm{H}) \\ & \mathrm{th}_{\mathrm{h}}(\mathrm{~L}) \\ & \hline \end{aligned}$ | Hold time An to LCAB | Waveform 4 | $\begin{aligned} & 1.0 \\ & 1.0 \\ & \hline \end{aligned}$ |  |  | $\begin{aligned} & 2.0 \\ & 1.0 \end{aligned}$ |  | ns |
| $\begin{aligned} & \mathrm{t}_{\mathrm{s}}(\mathrm{H}) \\ & \mathrm{t}_{\mathrm{s}}(\mathrm{~L}) \\ & \hline \end{aligned}$ | Setup time Bn to LCBA | Waveform 4 | $\begin{aligned} & 2.0 \\ & 2.0 \\ & \hline \end{aligned}$ |  |  | 3.0 <br> 3.0 |  | ns |
| $\begin{aligned} & \hline t_{h}(H) \\ & t_{h}(L) \end{aligned}$ | Hold time <br> Bn to LCBA | Waveform 4 | $\begin{aligned} & 0.0 \\ & 0.0 \end{aligned}$ |  |  | $\begin{aligned} & \hline 0.0 \\ & 0.0 \\ & \hline \end{aligned}$ |  | ns |
| $\begin{aligned} & \hline \mathrm{t}_{\mathrm{w}}(\mathrm{H}) \\ & \mathrm{t}_{\mathrm{w}}(\mathrm{~L}) \\ & \hline \end{aligned}$ | Pulse width, High or Low LCAB or LCBA | Waveform 4 | $\begin{aligned} & 3.0 \\ & 3.0 \end{aligned}$ |  |  | 3.0 <br> 3.0 |  | ns |

## AC SETUP REQUIREMENTS (Commercial)

| SYMBOL | PARAMETER | TEST CONDITION | LIMITS |  |  |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\mathrm{T}_{\text {amb }}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$, |  |  | $\begin{gathered} \mathrm{T}_{\mathrm{amb}}=0 \text { to }+70^{\circ} \mathrm{C}, \\ \mathrm{~V}_{\mathrm{cc}}=5 \mathrm{~V} \pm 10 \%, \end{gathered}$ |  |  |
|  |  |  | $\begin{gathered} C_{\mathrm{L}}=50 \mathrm{pF} \text { (A side) } / \mathrm{C}_{\mathrm{D}}=30 \mathrm{pF} \text { (B side) } \\ \mathrm{R}_{\mathrm{L}}=500 \Omega \text { (A side) } / \mathrm{R}_{\mathrm{U}}=16.5 \Omega \text { (B side) } \end{gathered}$ |  |  |  |  |  |
|  |  |  | MIN | TYP | MAX | MIN | MAX |  |
| $\begin{aligned} & \mathrm{t}_{\mathrm{s}}(\mathrm{H}) \\ & \mathrm{t}_{\mathrm{s}}(\mathrm{~L}) \\ & \hline \end{aligned}$ | Setup time An to LCAB | Waveform 4 | $\begin{aligned} & \hline 1.0 \\ & 1.0 \\ & \hline \end{aligned}$ |  |  | $\begin{aligned} & 1.5 \\ & 1.0 \\ & \hline \end{aligned}$ |  | ns |
| $\begin{aligned} & \mathrm{th}_{\mathrm{h}}(\mathrm{H}) \\ & \mathrm{t}_{\mathrm{h}}(\mathrm{~L}) \end{aligned}$ | Hold time <br> An to LCAB | Waveform 4 | $\begin{aligned} & \hline 1.0 \\ & 1.0 \\ & \hline \end{aligned}$ |  |  | $\begin{aligned} & 2.0 \\ & 1.0 \\ & \hline \end{aligned}$ |  | ns |
| $\begin{aligned} & \mathrm{t}_{\mathrm{s}}(\mathrm{H}) \\ & \mathrm{t}_{\mathrm{s}}(\mathrm{~L}) \\ & \hline \end{aligned}$ | $\begin{aligned} & \text { Setup time } \\ & \text { Bn to LCBA } \end{aligned}$ | Waveform 4 | $\begin{aligned} & \hline 2.0 \\ & 2.0 \\ & \hline \end{aligned}$ |  |  | $\begin{aligned} & 3.0 \\ & 3.0 \\ & \hline \end{aligned}$ |  | ns |
| $\begin{aligned} & \mathrm{t}_{\mathrm{h}}(\mathrm{H}) \\ & \mathrm{t}_{\mathrm{h}}(\mathrm{~L}) \end{aligned}$ | Hold time $\overline{B n}$ to LCBA | Waveform 4 | $\begin{aligned} & \hline 0.0 \\ & 0.0 \\ & \hline \end{aligned}$ |  |  | $\begin{aligned} & \hline 0.0 \\ & 0.0 \\ & \hline \end{aligned}$ |  | ns |
| $\begin{aligned} & \mathrm{t}_{\mathrm{w}}(\mathrm{H}) \\ & \mathrm{t}_{\mathrm{w}}(\mathrm{~L}) \\ & \hline \end{aligned}$ | Pulse width, High or Low LCAB or LCBA | Waveform 4 | $\begin{aligned} & \hline 3.0 \\ & 3.0 \\ & \hline \end{aligned}$ |  |  | $\begin{aligned} & 3.0 \\ & 3.0 \\ & \hline \end{aligned}$ |  | ns |

## AC WAVEFORMS



Waveform 1. Propagation Delay for Data or Output Enable to Output


Waveform 3. Output to Output Skew


Waveform 5. 3-State Output Enable Time to High Level and Output Disable Time from High Level

NOTE: $\mathrm{V}_{\mathrm{M}}=1.55 \mathrm{~V}$ for $\mathrm{Bn}, \mathrm{V}_{\mathrm{M}}=1.5 \mathrm{~V}$ for all others.
The shaded areas indicate when the input is permitted to change for predictable output performance

## TEST CIRCUIT AND WAVEFORMS



detail X


DIMENSIONS (mm are the original dimensions)

| UNIT | $\mathbf{A}$ <br> $\mathbf{m a x}$. | $\mathbf{A}_{\mathbf{1}}$ | $\mathbf{A}_{\mathbf{2}}$ | $\mathbf{A}_{\mathbf{3}}$ | $\mathbf{b}_{\mathbf{p}}$ | $\mathbf{c}$ | $\mathbf{D}^{(1)}$ | $\mathbf{E}^{(1)}$ | $\mathbf{e}$ | $\mathbf{H}_{\mathbf{D}}$ | $\mathbf{H}_{\mathbf{E}}$ | $\mathbf{L}$ | $\mathbf{L}_{\mathbf{p}}$ | $\mathbf{v}$ | $\mathbf{w}$ | $\mathbf{y}$ | $\mathbf{Z}_{\mathbf{D}}^{(1)}$ | $\mathbf{Z}_{\mathbf{E}}^{(1)}$ | $\boldsymbol{\theta}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | 2.45 | 0.45 | 2.10 | 0.25 | 0.38 | 0.23 | 10.1 | 10.1 | 0.65 | 13.45 | 13.45 | 1.60 | 0.95 | 0.20 | 0.12 | 0.10 | 1.24 | 1.24 | $7^{0}$ |
| 0 | 0.95 | 0.25 | 0.22 | 0.13 | 9.9 | 9.9 | 0.6 | 12.95 | 12.95 | 0.95 | 0.65 | 0.95 | $0^{0}$ |  |  |  |  |  |  |

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

| OUTLINE VERSION | REFERENCES |  |  | EUROPEAN PROJECTION | ISSUE DATE |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | IEC | JEDEC | EIAJ |  |  |
| SOT379-1 |  | MO-108 |  | $\square$ - | $\begin{aligned} & -95-02-04 \\ & 97-08-04 \end{aligned}$ |

## NOTES

Data sheet status

| Data sheet <br> status | Product <br> status | Definition [1] |
| :--- | :--- | :--- |
| Objective <br> specification | Development | This data sheet contains the design target or goal specifications for product development. <br> Specification may change in any manner without notice. |
| Preliminary <br> specification | Qualification | This data sheet contains preliminary data, and supplementary data will be published at a later date. <br> Philips Semiconductors reserves the right to make chages at any time without notice in order to <br> improve design and supply the best possible product. |
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